

08-14-1998



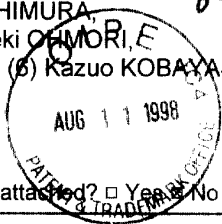
To the Honorable Commissioner of Patent
Please record the attached original docum

100793639

INTERNATIONAL BOX ASSIGNMENTS

1. Name of conveying party(ies):
(1) Junzo UKAI, (2) Hideo NISHIMURA,
(3) Yoshitsugu TAKAI, (4) Hideki OHMORI,
(5) Toshihiko NAKAMURA and (6) Kazuo KOBAYASHI

MAD
8-11-98



2. Name and address of receiving party(ies):
Name: (1) SANYO CHEMICAL INDUSTRIES, LTD.
(2) TOYOTA JIDOSHA KABUSHIKI KAISHA

Additional name(s) of conveying party(ies) attached? Yes No

Internal Address:
Street Address: (1) 11-1, Ikkyonomoto-cho,
Higashiyama-ku, Kyoto-shi, Kyoto-fu,
605, Japan
(2) 1, Toyota-cho, Toyota-shi, Aichi-ken,
471, Japan

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name

City:
State: Zip Code:

Other
Execution Date: (1) and (2) May 25, 1998, (3) and (4) June 24,
1998, (5) May 26, 1998 and (6) June 9, 1998

Additional name(s) & Address(es) attached?
 Yes No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:
A. Patent Application Number(s): 09/089,345
B. Patent Number(s):
Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: Mr. Ernest F. Chapman
Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.
08/13/1998 ISHABAZZ 00000053 09089345
01 FC:561 40.00 DP
Street Address: 1300 I Street, N.W.
City: Washington
State: DC Zip: 20005-3315

6. Total number of applications and registrations involved: 1
7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)
Authorized to be charged to deposit account
8. Deposit account number: 06-0916

9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Ernest F. Chapman
Signature: *Ernest F. Chapman* Date: August 11, 1998

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), hereinafter referred to as Assignor(s) , have made an invention entitled:

POLYURETHANE RESIN TYPE COMPOSITION FOR SLUSH MOLDING

for which I/WE executed an application for United States Letters Patent concurrently herewith or on _____ or filed an application for United States Letters Patent on June 3, 1998 (Serial No. 09/089,345); and

WHEREAS, SANYO CHEMICAL INDUSTRIES, LTD., a corporation of Japan, whose post office address is 11-1, Ikkyonomoto-cho, Higashiyama-ku, Kyoto-shi, Kyoto-fu, 605, Japan; and TOYOTA JIDOSHA KABUSHIKI KAISEA, a corporation of Japan, whose address is 1, Toyota-cho, Toyota-shi, Aichi-ken, 471, Japan, (hereinafter referred to as Assignees), are desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignees are hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignees, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignees, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignees, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignees, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignees, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignees, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. Full Name of Sole or First Assignor : Assignor's Signature : Date
 Junzo UKAI : *Junzo Ukai* : May 25, 1998
 Address : Citizenship
 171 Aza Yosidono, Takimachi, Okazaki-shi, Aichi-ken, 444-31, Japan : Japan
2. Full Name of Second Assignor : Assignor's Signature : Date
 Hideo NISHIMURA : *Hideo Nishimura* : May 25, 1998
 Address : Citizenship
 4-4-15 Itsutsugaoka, Toyota-shi, Aichi-ken, 471, Japan : Japan
3. Full Name of Third Assignor : Assignor's Signature : Date
 Yoshitsugu TAKAI : *Yoshitsugu Takai* : June 24, 1998
 Address : Citizenship
 23 Dewayashiki-cho, Fukakusa, Fushimi-ku, Kyoto-shi, Kyoto-fu, Japan : Japan
4. Full Name of Fourth Assignor : Assignor's Signature : Date
 Hideki OHMORI : *Hideki Ohmori* : June 24, 1998
 Address : Citizenship
 7-3 Goyounotsuzi-cho, Senyuuji, Higashiyama-ku, Kyoto-shi, Kyoto-fu, Japan : Japan
5. Full Name of Fifth Assignor : Assignor's Signature : Date
 Toshihiko NAKAMURA : *Toshihiko Nakamura* : May 26, 1998
 Address : Citizenship
 6-8-1 Itsutsugaoka, Toyota-shi, Aichi-ken, 471, Japan : Japan
6. Full Name of Sixth Assignor : Assignor's Signature : Date
 Kazuo KOBAYASHI : *Kazuo Kobayashi* : June 9, 1998
 Address : Citizenship
 5-308-1 Miyukihonmachi, Toyota-shi, Aichi-ken, 471, Japan : Japan